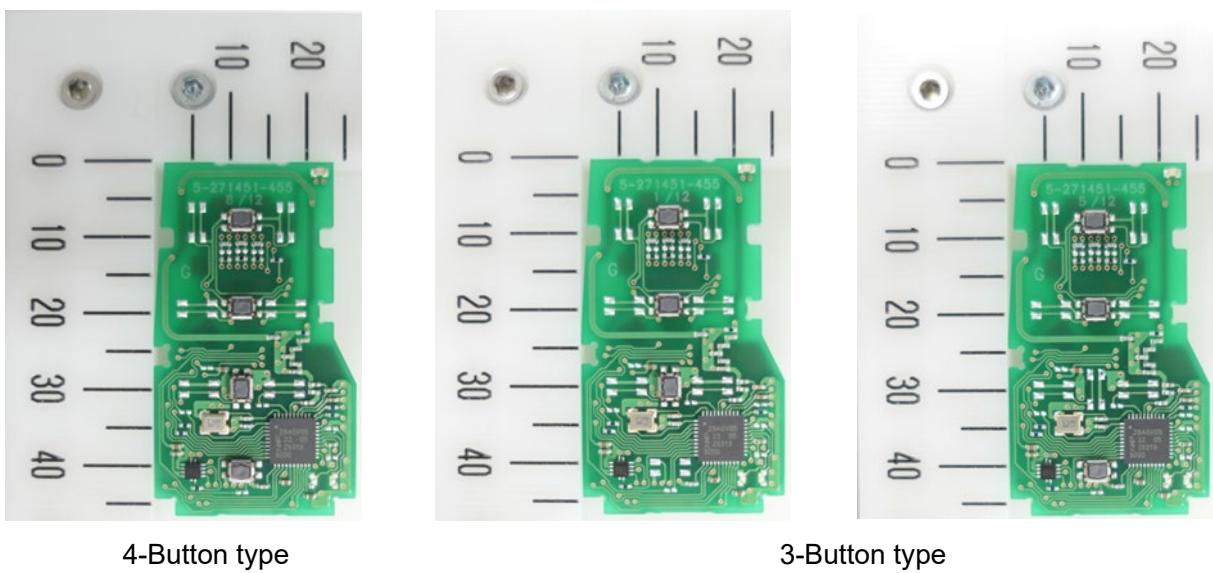
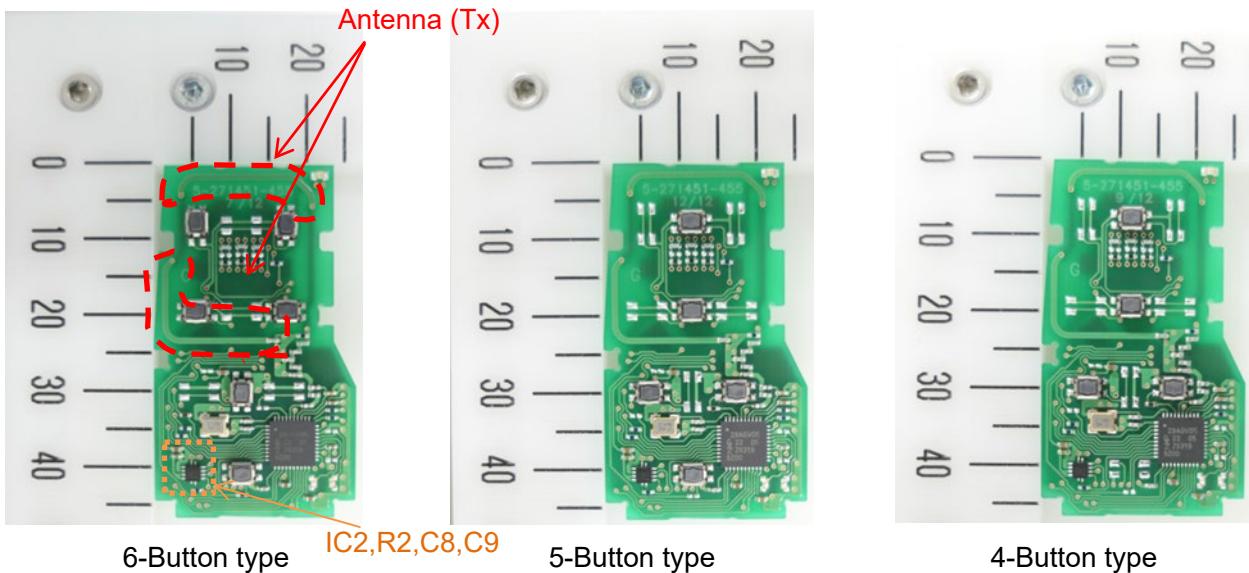


Internal Photos (Type A: IC2, R2, C8 and C9 are mounted.)

Component side



Note:

The difference in the number and / or location of switches has no influence on RF performance.

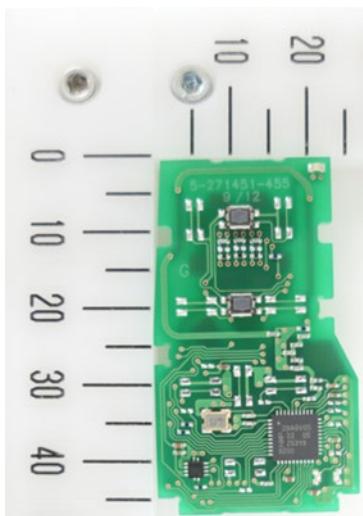
Type A and Type B are equivalent in terms of RF performance.

Marking location is inside the outer case or on the module cover.

**DENSO CORPORATION**  
**Electronic Key**  
**Model: 14FNB**

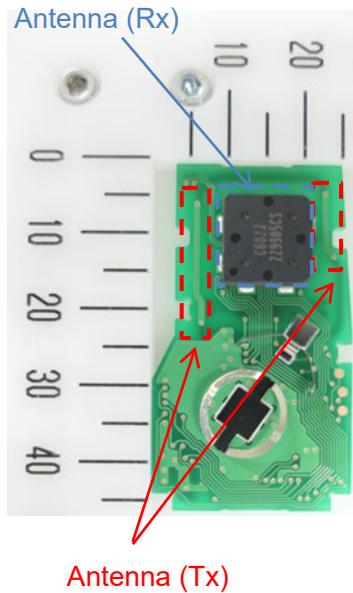
Internal Photos (Type A: IC2, R2, C8 and C9 are mounted.)

Component side



2-Button type

Solder side (Common)



Marking location

< On the module cover >



< Inside the outer case >



Note:

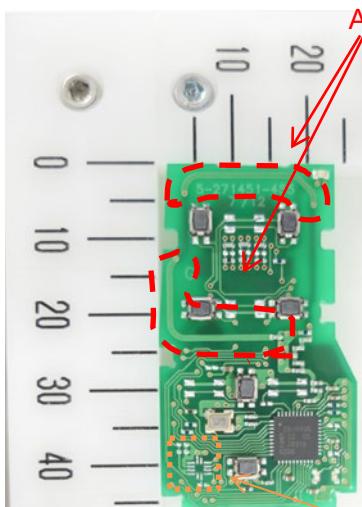
The difference in the number and / or location of switches has no influence on RF performance.

Type A and Type B are equivalent in terms of RF performance.

Marking location is inside the outer case or on the module cover.

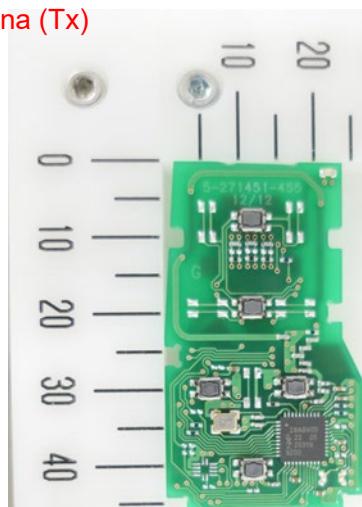
Internal Photos (Type B: IC2, R2, C8 and C9 are not mounted.)

Component side

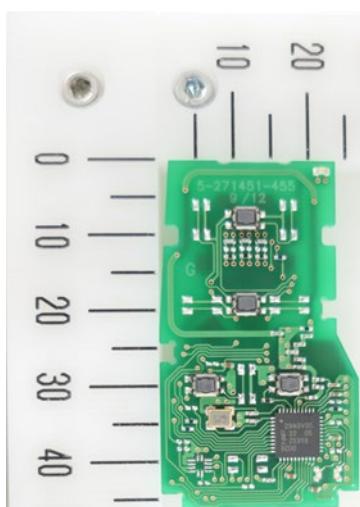


6-Button type

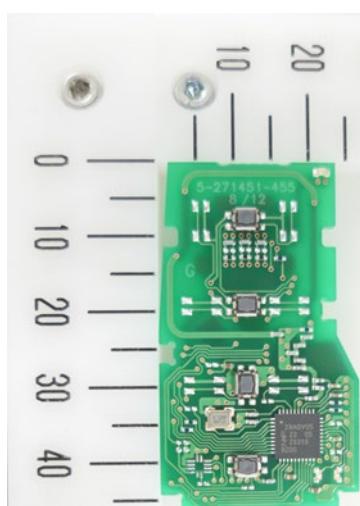
Not mounted



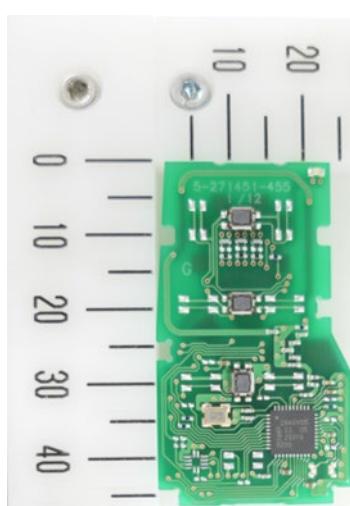
5-Button type



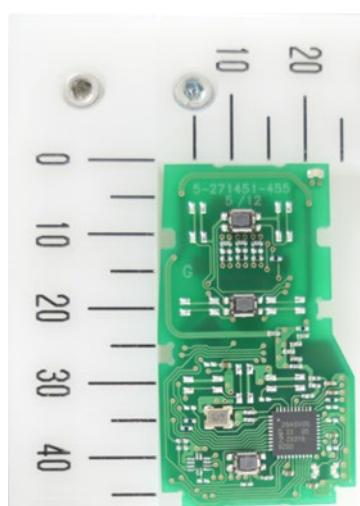
4-Button type



4-Button type



3-Button type



Note:

The difference in the number and / or location of switches has no influence on RF performance.

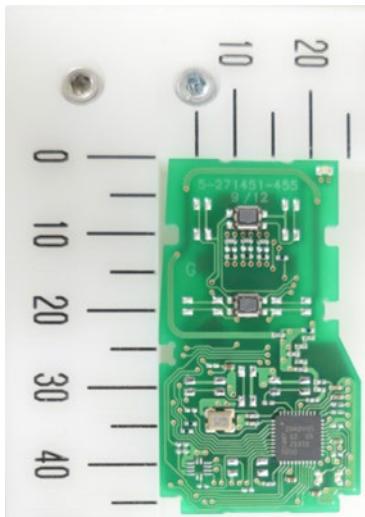
Type A and Type B are equivalent in terms of RF performance.

Marking location is inside the outer case or on the module cover.

**DENSO CORPORATION**  
**Electronic Key**  
**Model: 14FNB**

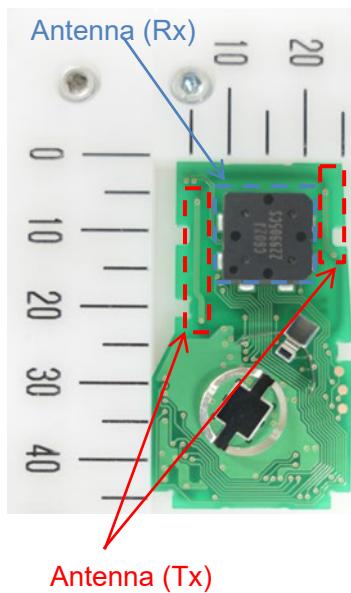
Internal Photos (Type B: IC2, R2, C8 and C9 are not mounted.)

Component side



2-Button type

Solder side (Common)



Marking location

< On the module cover >



< Inside the outer case >



Note:

The difference in the number and / or location of switches has no influence on RF performance.

Type A and Type B are equivalent in terms of RF performance.

Marking location is inside the outer case or on the module cover.